



OR6272BSBC

**0.85V Minimum Input and 5.5V Maximum Output
High Efficiency 2A Valley Current Synchronous Boost**

General Description

OR6272BSBC is a high efficient, synchronous, step-up Boost converter designed for one-cell Li-Ion or Li-polymer, or a two to three-cell alkaline Ni-Cd or Ni-MH battery powered applications. It can convert down to 0.85V input voltage. It adopts NMOS for the main switch and PMOS for the synchronous switch.

OR6272BSBC can disconnect the output from input during the shutdown mode. When input voltage exceeds the regulated output voltage, OR6272BSBC enters bypass mode automatically.

Features

- 0.85V Minimum Input Voltage
- Adjustable Output Voltage from 1.8V to 5.5V
- Min 2A Valley Current Limit
- 5 μ A Typical Quiescent Current
- Load Disconnect During Shutdown
- Low $R_{DS(ON)}$ (Main Switch/Synchronous Switch) at 3.3V Output: 100/170m Ω
- Output OVP
- RoHS Compliant and Halogen Free
- Auto Bypass Mode When $V_{IN} \geq V_{OUT}$
- Compact Package SOT23-6

Ordering Information

OR6272□(□□)□
 └─ Temperature Code
 └─ Package Code
 └─ Optional Spec Code

Ordering Number	Package type	Note
OR6272BSBC	SOT23-6	----

Applications

- All Single Cell Li or Dual Cell Battery Operated Products as MP-3 Player, PDAs, and Other Portable Equipment

Typical Applications

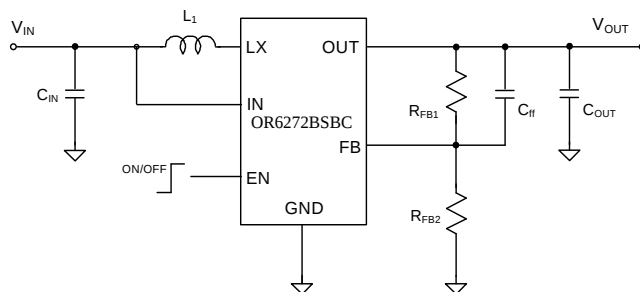


Figure 1. Schematic Diagram

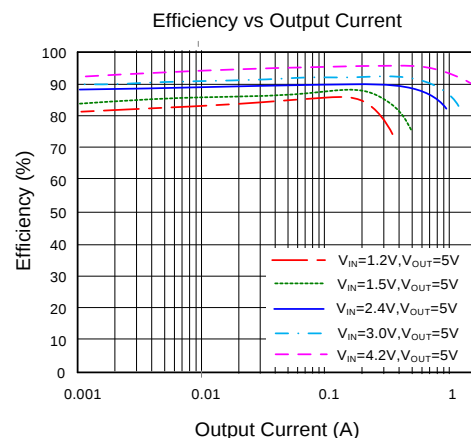
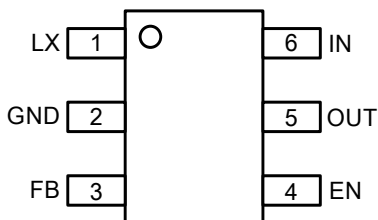


Figure 2. Efficiency vs. Load Current



OR6272BSBC

Pinout (top view)



(SOT23-6)

Top mark: **cKxyz** for OR6272BSBC (Device code: **cK**, x=*year code*, y=*week code*, z=*lot number code*)

Pin Name	Pin Number	Pin Description
LX	1	Inductor node. Connect an inductor between the IN pin and the LX pin.
GND	2	Ground pin.
FB	3	Feedback pin. Connect a resistor R_{FB1} between OUT and FB, and a resistor R_{FB2} between FB and GND to program the output voltage. $V_{OUT}=1.2V \times (R_{FB1}/R_{FB2}+1)$.
EN	4	Enable pin. Pull high to turn on. Do not leave it floating.
OUT	5	Output pin. Decouple this pin to the GND pin with a minimum of 22 μ F ceramic capacitor.
IN	6	Input pin.

Block Diagram

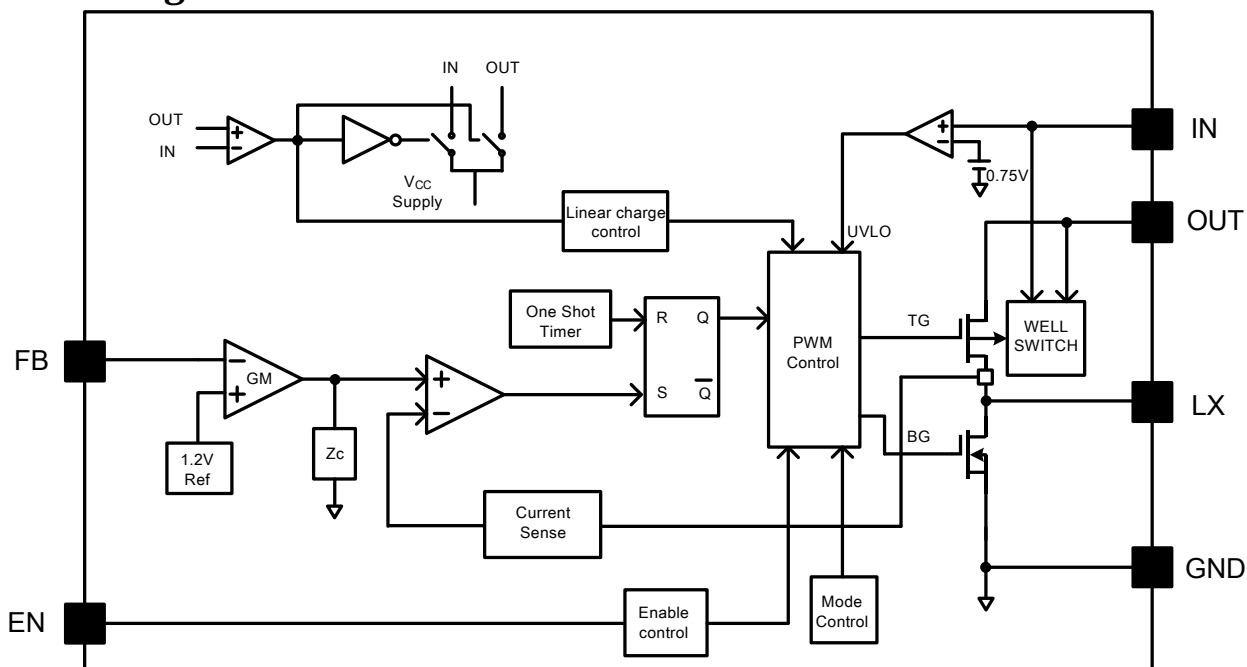


Figure3. Block Diagram



Absolute Maximum Ratings (Note 1)

FB, IN, OUT, EN	-----	-0.3V to 6.0V
LX	-----	-0.3V ^{(*)1} to 6.0V ^{(*)2}
Power Dissipation, P _D @ T _A =25°C SOT23-6	-----	1W
Package Thermal Resistance (Note 2)		
θ _{JA}	-----	100°C/W
θ _{JC}	-----	30°C/W
Junction Temperature Range	-----	-40°C to 150°C
Lead Temperature (Soldering, 10 sec.)	-----	260°C
Storage Temperature Range	-----	-65°C to 150°C
(*)1 LX Voltage tested down to -3V< 20ns		
(*)2 LX Voltage tested up to +7V< 20ns		

Recommended Operating Conditions (Note 3)

IN	-----	0.85V to 5.5V
OUT	-----	1.8V to 5.5V
EN	-----	0V to V _{OUT} +0.3V
All Other Pins	-----	0 to 5.5V
Junction Temperature Range	-----	-40°C to 125°C
Ambient Temperature Range	-----	-40°C to 85°C



Electrical Characteristics

($V_{IN}=2.4V$, $V_{OUT}=3.3V$, $I_{OUT}=500mA$, $T_A = 25^{\circ}C$, unless otherwise specified)

Parameter	Symbol	Test Conditions	Min	Typ	Max	Unit
Input Voltage Range	V_{IN}		0.85		5.5	V
Input UVLO Threshold	V_{UVLO}			0.7	0.85	V
Input UVLO Hysteresis	V_{HYS}			0.04		V
Quiescent Current	V_{IN}	$V_{FB}=1.3V, V_{EN}=V_{IN}=1V, V_{OUT}=3.4V$		0.7		μA
	V_{OUT}			5		μA
Shutdown Current	I_{SHDN}	$V_{EN}=0V, V_{IN}=2.4V$		0.1	1	μA
Linear Charge Current	I_{CHARGE}	$V_{OUT}<0.5V_{IN}$		1		A
Feedback Reference Voltage	V_{REF}		1.182	1.2	1.218	V
Low Side Main FET R_{ON}	$R_{DS(ON)1}$			100		$m\Omega$
Synchronous FET R_{ON}	$R_{DS(ON)2}$			170		$m\Omega$
EN Input Voltage High	$V_{EN,H}$	$V_{IN}\leq 1.6V$ and $V_{OUT}\leq 1.6V$	0.7			V
		$V_{IN}>1.6V$ or $V_{OUT}>1.6V$	1.2			V
EN Input Voltage Low	$V_{EN,L}$	$V_{IN}\leq 1.6V$ and $V_{OUT}\leq 1.6V$			0.25	V
		$V_{IN}>1.6V$ or $V_{OUT}>1.6V$			0.4	V
EN Leakage Current	$I_{EN,LK}$	$V_{EN}=3.3V$	-1		1	μA
Min ON Time	$t_{ON,MIN}$			60		ns
Min OFF Time	$t_{OFF,MIN}$			140		ns
Soft-start Time	t_{SS}			1		ms
Switching Frequency	F_{SW}	$V_{OUT}=3.3V$, CCM		1		MHz
Valley FET Current Limit	$I_{LMT,VAL}$		2			A
Output Over Voltage Threshold	V_{OVP}			5.8		V
Output Over Voltage Hysteresis	$V_{OVP,HYS}$			0.3		V
Thermal Shutdown Temperature	T_{SD}			150		$^{\circ}C$
Thermal Shutdown Hysteresis	T_{HYS}			20		$^{\circ}C$

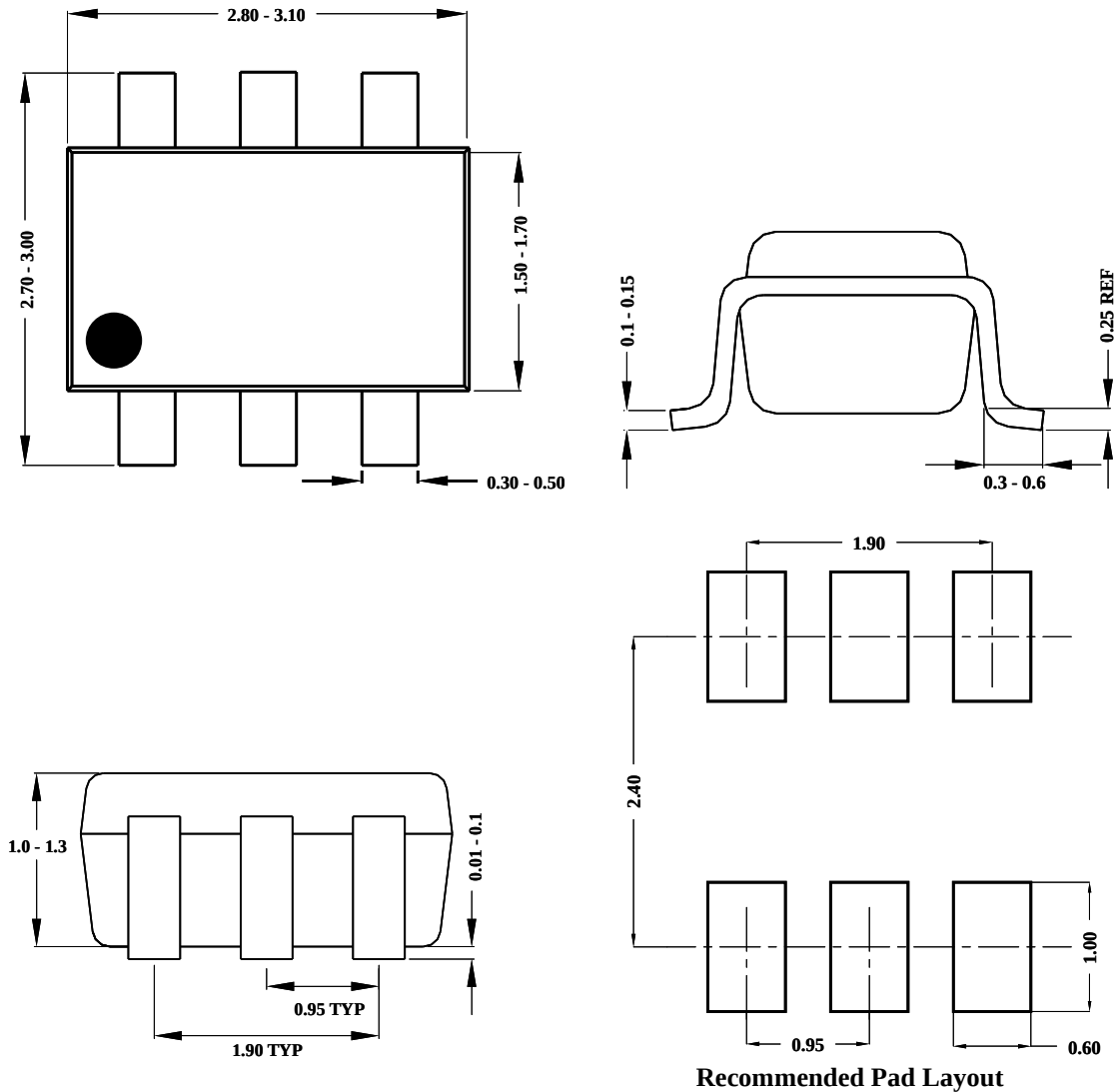
Note 1: Stresses beyond the “Absolute Maximum Ratings” may cause permanent damage to the device. These are stress ratings only. Functional operation of the device at these or any other conditions beyond those indicated in the operational sections of the specification is not implied. Exposure to absolute maximum rating conditions may affect device reliability.

Note 2: Package thermal resistance is measured in the natural convection at $T_A = 25^{\circ}C$ on a two-layer Orange Evaluation Board.

Note 3: The device is not guaranteed to function outside its operating conditions.



SOT23-6 Package Outline & PCB Layout Design

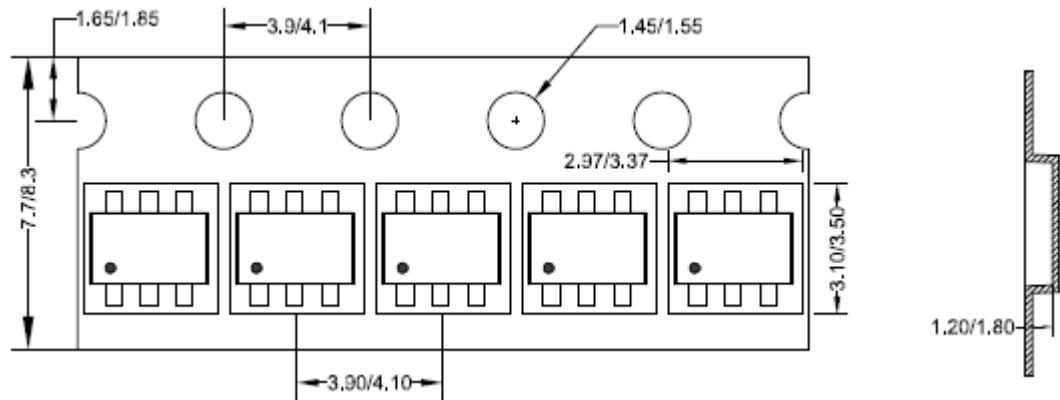


Notes: All dimensions are in millimeters.
All dimensions don't include mold flash & metal burr.



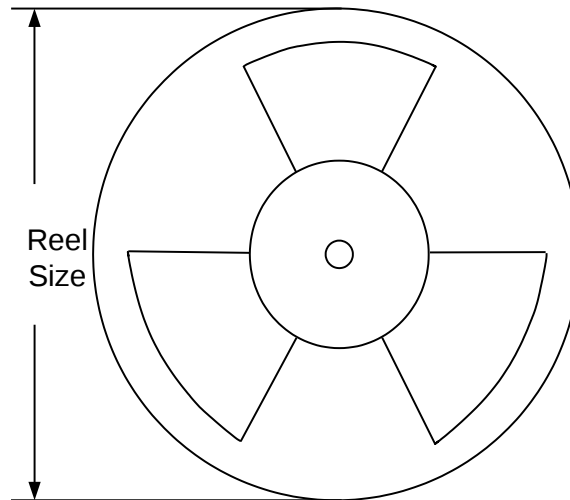
Taping & Reel Specification

1. Taping orientation for packages (SOT23-6)



Feeding direction →

2. Carrier Tape & Reel specification for packages



Package type	Tape width (mm)	Pocket pitch(mm)	Reel size (Inch)	Trailer length(mm)	Leader length (mm)	Qty per reel
SOT23-6	8	4	7"	280	160	3000

3. Others: NA